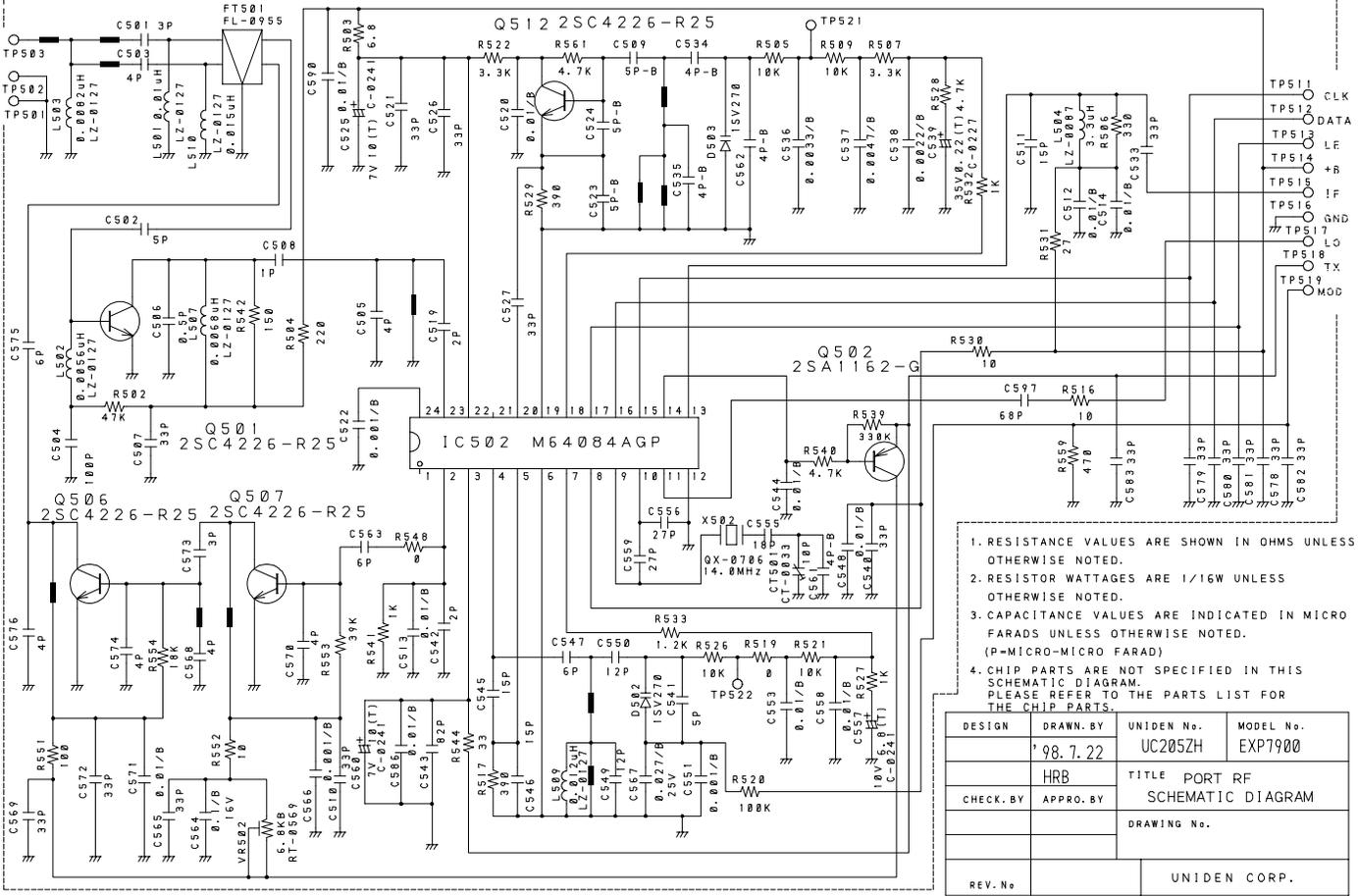


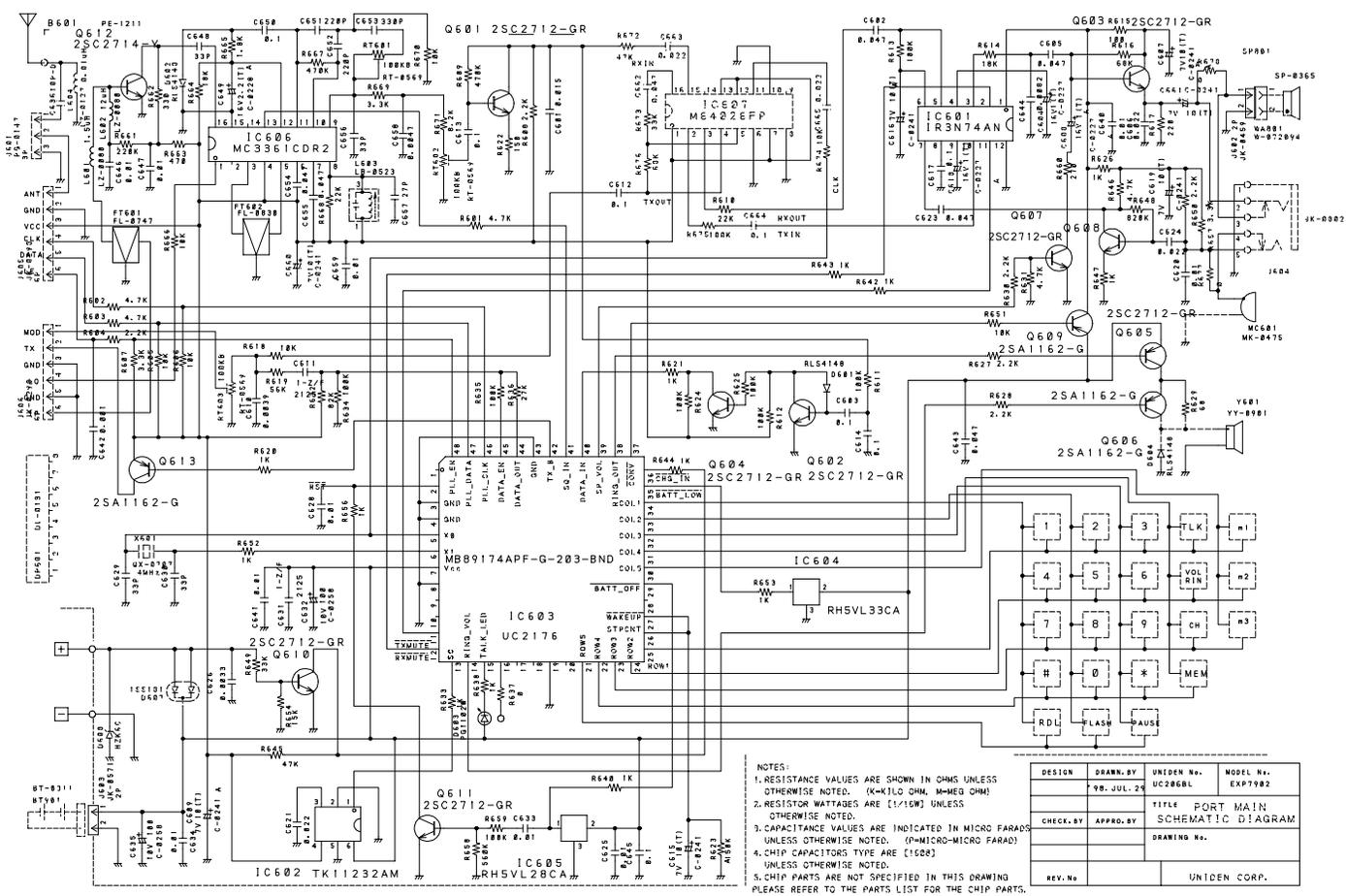
- NOTES:
1. RESISTANCE VALUES ARE SHOWN IN OHMS UNLESS OTHERWISE NOTED. (K=KILO OHM, M=MEG OHM)
 2. RESISTOR WATTAGES ARE (1/10W) UNLESS OTHERWISE NOTED.
 3. CAPACITANCE VALUES ARE INDICATED IN MICRO FARADS UNLESS OTHERWISE NOTED. (P=PICTO-MICRO FARAD)
 4. CHIP CAPACITORS TYPE ARE (1255) UNLESS OTHERWISE NOTED.
 5. CHIP PARTS ARE NOT SPECIFIED IN THIS DRAWING PLEASE REFER TO THE PARTS LIST FOR THE CHIP PARTS.

DESIGN	DRAWN BY	UNIDEN No.	MODEL No.
	TR/KUN	UC-286RL	EXP1782
CHECK BY	APPROV BY	TITLE BASE MAIN PCB SCHEMATIC DIAGRAM	
		DRAWING No.	
REV. No	2	UNIDEN CORP.	



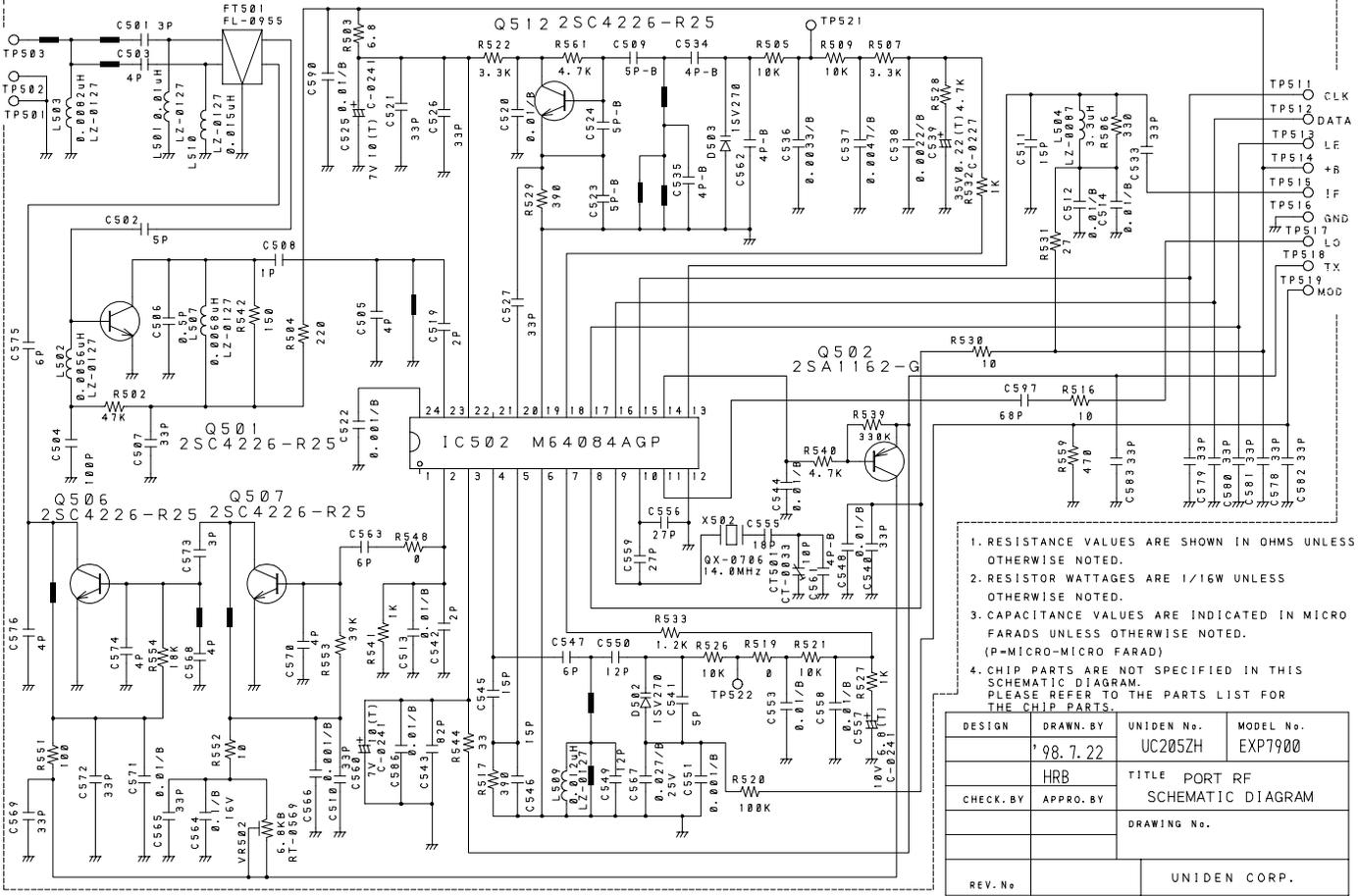
1. RESISTANCE VALUES ARE SHOWN IN OHMS UNLESS OTHERWISE NOTED.
2. RESISTOR WATTAGES ARE 1/16W UNLESS OTHERWISE NOTED.
3. CAPACITANCE VALUES ARE INDICATED IN MICRO FARADS UNLESS OTHERWISE NOTED. (P-MICRO-MICRO FARAD)
4. CHIP PARTS ARE NOT SPECIFIED IN THIS SCHEMATIC DIAGRAM. PLEASE REFER TO THE PARTS LIST FOR THE CHIP PARTS.

DESIGN	DRAWN BY	UNIDEN No.	MODEL No.
	98.7.22	UC205ZH	EXPT900
CHECK BY	APPROV BY	TITLE PORT RF SCHEMATIC DIAGRAM	
		DRAWING No.	
REV. No		UNIDEN CORP.	



- NOTES:
1. RESISTANCE VALUES ARE SHOWN IN OHMS UNLESS OTHERWISE NOTED. (K=KIL OHM, M=MEG OHM)
 2. RESISTOR WATTAGES ARE [1/16W] UNLESS OTHERWISE NOTED.
 3. CAPACITANCE VALUES ARE INDICATED IN MICRO FARADS UNLESS OTHERWISE NOTED. (P=MICRO-MICRO FARAD)
 4. CHIP CAPACITORS TYPE ARE [1608]
 5. CHIP PARTS ARE NOT SPECIFIED IN THIS DRAWING UNLESS OTHERWISE NOTED.
- PLEASE REFER TO THE PARTS LIST FOR THE CHIP PARTS.

DESIGN	DRAWN BY	UNIDEN No.	MODEL No.
	98. JUL. 2K	UC2080L	EXPT982
CHECK BY	APPROD BY	TITLE PORT MAIN SCHEMATIC DIAGRAM	
		DRAWING No.	
REV. No		UNIDEN CORP.	



1. RESISTANCE VALUES ARE SHOWN IN OHMS UNLESS OTHERWISE NOTED.
2. RESISTOR WATTAGES ARE 1/16W UNLESS OTHERWISE NOTED.
3. CAPACITANCE VALUES ARE INDICATED IN MICRO FARADS UNLESS OTHERWISE NOTED. (P-MICRO-MICRO FARAD)
4. CHIP PARTS ARE NOT SPECIFIED IN THIS SCHEMATIC DIAGRAM. PLEASE REFER TO THE PARTS LIST FOR THE CHIP PARTS.